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PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying parties/Execution Dates: **P E**

- (1) Hiroshi HOZOJI
- (2) Toshiaki MORITA
- (3) Hiroshi SASAKI

Execution Dates (1 and 2) January 16, 2004
(3) January 22, 2004

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other ___

2. Name and address of receiving party

Name: **HITACHI LTD.**

Street Address: **6-6, Marunouchi 1-chome,
Chiyoda-ku, Tokyo,
Japan**

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s): This document is being filed together with a new application.

A. Patent Application No.(s)

10/996,038

B. Patent Registration No.(s)

Additional number(s) attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Crowell & Moring LLP**

Street Address: **Intellectual Property Group
PO Box 14300
Washington, DC 20044-4300**

Phone Number: **202-624-2500**

Fax Number: **202-628-8844**

6. Total number of applications and patents involved **1**

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers

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b. Deposit Account Number **05-1323**

Authorized User Name

9. Signature:

Gary R Edwards
Signature

April 18, 2005

Date

Gary R. Edwards, 31,824

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: **2**

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PATENT
REEL: 016467 FRAME: 0383

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ELECTRONIC PART MOUNTING METHOD, SEMICONDUCTOR MODULE, AND SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

| | | |
|-----|---|-----------------------|
| 1) | <u>Hiroshi Hojoji</u> Hiroshi HOZOJI | <u>11 / 16 / 2004</u> |
| 2) | <u>Toshiaki Morita</u> Toshiaki MORITA | <u>11 / 16 / 2004</u> |
| 3) | <u>Hiroshi Sasaki</u> Hiroshi SASAKI | <u>11 / 22 / 2004</u> |
| 4) | _____ | _____ |
| 5) | _____ | _____ |
| 6) | _____ | _____ |
| 7) | _____ | _____ |
| 8) | _____ | _____ |
| 9) | _____ | _____ |
| 10) | _____ | _____ |